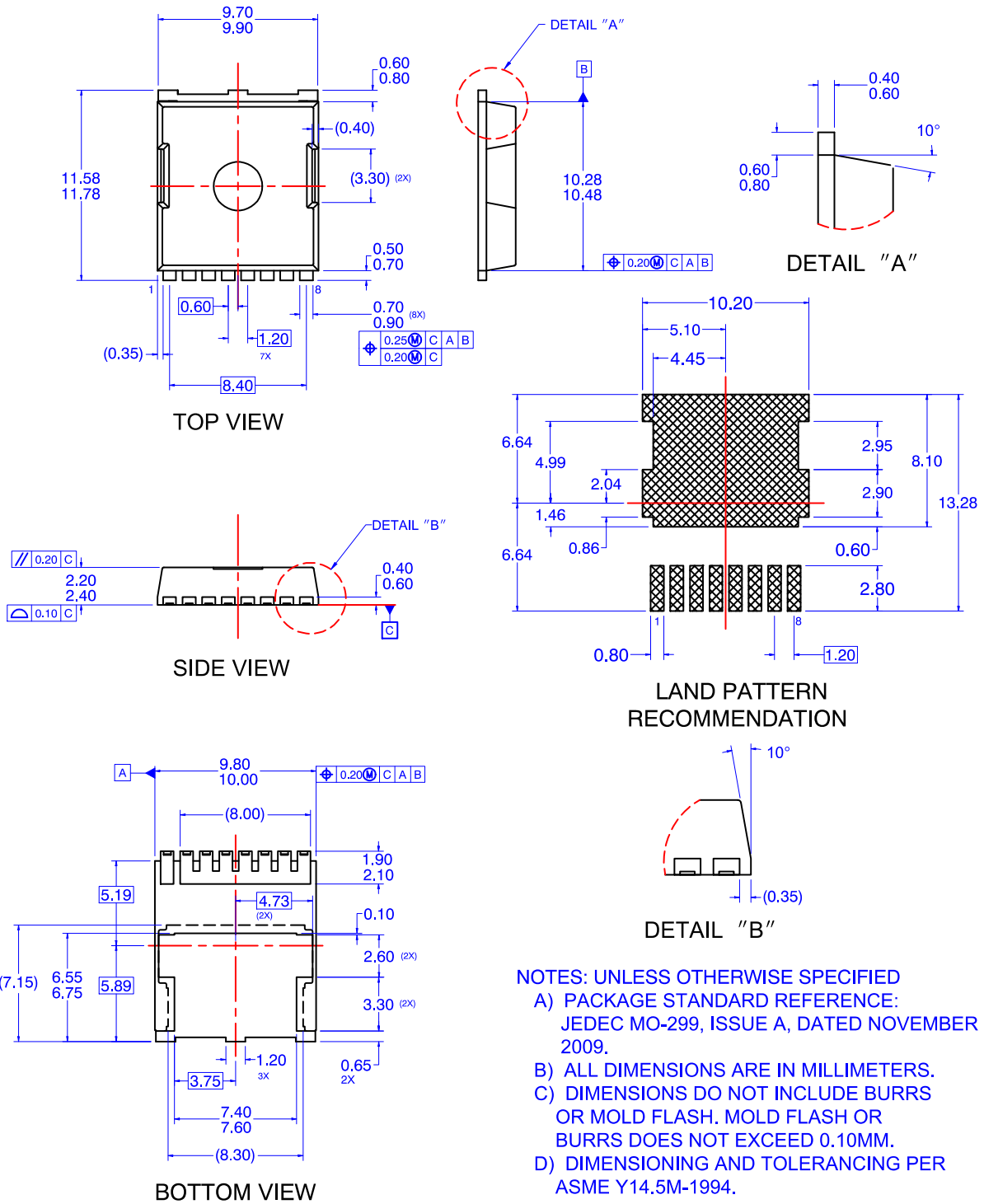


**H-PSOF8L 11.68x9.80**  
**CASE 100CU**  
**ISSUE O**

DATE 30 NOV 2016



- NOTES: UNLESS OTHERWISE SPECIFIED**
- A) PACKAGE STANDARD REFERENCE: JEDEC MO-299, ISSUE A, DATED NOVEMBER 2009.
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
  - D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

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<b>STATUS:</b>	<b>ON SEMICONDUCTOR STANDARD</b>	
<b>NEW STANDARD:</b>		
<b>DESCRIPTION:</b>	<b>H-PSOF8L 11.68x9.80</b>	<b>PAGE 1 OF 2</b>

